

FEATURES

- **Guaranteed AC performance over temperature and voltage:**
 - >10.7Gbps data throughput
 - <60ps t_r/t_f times
 - <350ps t_{pd} (IN-to-Q)
 - <20ps skew
- **Low jitter:**
 - <10ps_{pp} total jitter (clock)
 - <1ps_{rms} random jitter (data)
 - <10ps_{pp} deterministic jitter (data)
- **Crosstalk induced jitter: <0.7ps_{rms}**
- **Unique, patent-pending input isolation minimizes adjacent channel crosstalk**
- **Accepts an input signal as low as 100mV**
- **Unique, patent-pending input termination and VT pin accepts DC-coupled and AC-coupled differential inputs: LVPECL, LVDS, and CML**
- **Fully differential inputs/outputs**
- **50Ω source terminated CML outputs**
- **Power supply 2.5V ±5% and 3.3V ±10%**
- **Industrial -40°C to +85°C temperature range**
- **Available in 32-pin (5mm × 5mm) MLF™ package**

**Precision Edge™**

DESCRIPTION

The SY58024U is a 2.5V/3.3V precision, high-speed, fully differential dual CML crosspoint switch. The SY58024U is optimized to provide two identical output copies with less than 20ps of skew and ultra-low jitter. The SY58024U can process clock signals as fast as 6GHz or data patterns up to 10.7Gbps.

The differential input includes Micrel's unique, 3-pin input termination architecture that allows the SY58024U to directly interface to LVPECL, LVDS, and CML differential signal (AC- or DC-coupled) without any level-shifting or termination resistor networks in the signal path. The CML outputs features a 400mV typical swing into 50Ω loads, and provides an extremely fast rise/fall time guaranteed to be less than 60ps.

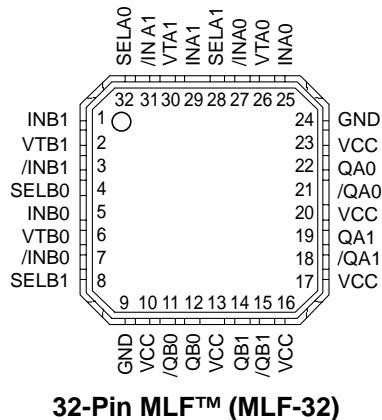
The SY58024U operates from a 2.5V ±5% supply or 3.3V ±10% supply and is guaranteed over the full industrial temperature range (-40°C to +85°C). For applications that require high-speed single channel CML switches, consider the SY58023U. The SY58024U is part of Micrel's high-speed, Precision Edge™ product line.

Data sheets and support documentation can be found on Micrel's website at www.micrel.com.

APPLICATIONS

- **Gigabit Ethernet data/clock routing**
- **SONET data/clocking routing**
- **Switch fabric clock routing**
- **Redundant switchover**
- **Backplane redundancy**

PACKAGE/ORDERING INFORMATION

Ordering Information⁽¹⁾

Part Number	Package Type	Operating Range	Package Marking	Lead Finish
SY58024UMI	MLF-32	Industrial	SY58024U	Sn-Pb
SY58024UMITR ⁽²⁾	MLF-32	Industrial	SY58024U	Sn-Pb
SY58024UMY	MLF-32	Industrial	SY58024U with "Y" designator	Pb-Free
SY58024UMYTR ⁽²⁾	MLF-32	Industrial	SY58024U with "Y" designator	Pb-Free

Notes:

1. Contact factory for die availability. Dice are guaranteed at $T_A = 25^\circ\text{C}$, DC electricals only.
2. Tape and Reel.

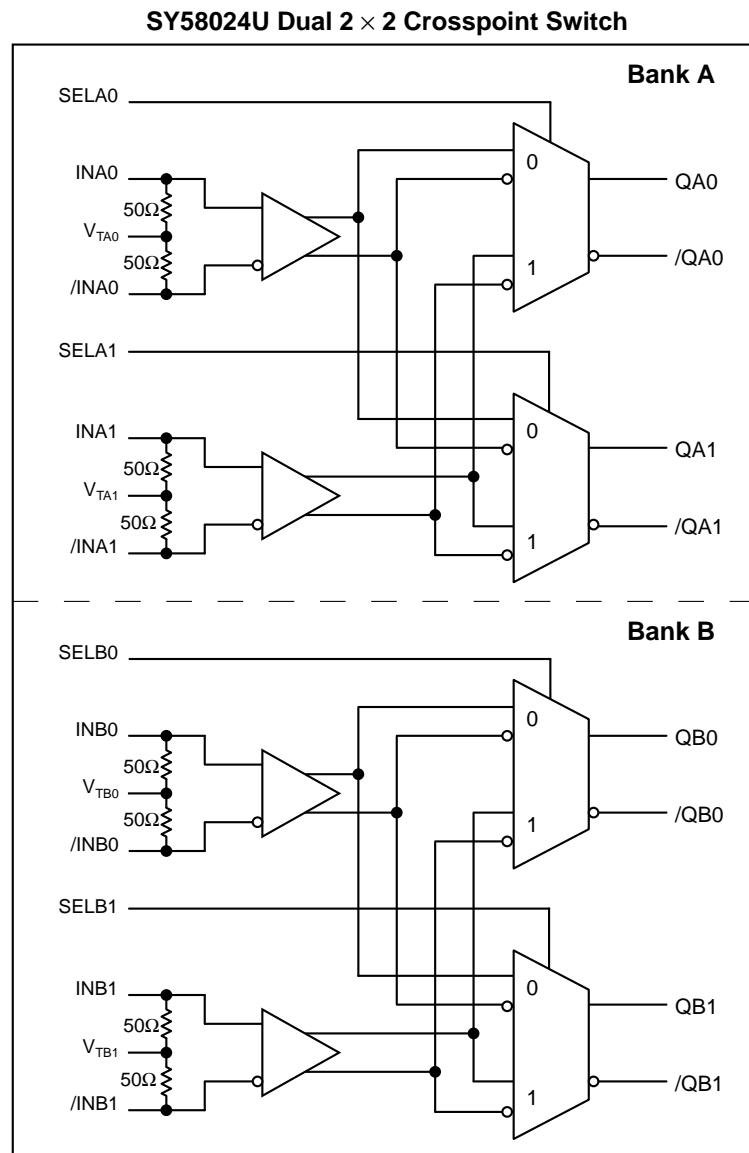
PIN DESCRIPTION

Pin Number	Pin Name	Pin Function
25, 27 29, 31, 1, 3, 5, 7	INA0, /INA0, INA1, /INA1, INB1, /INB1 INB0, /INB0	Differential Signal: Each pin of this pair internally terminates with 50Ω to the VT pin. The input will default to an indeterminate state if left open. See "Input Interface Application" section.
26, 30 2, 6	VTA0, VTA1, VTB1, VTB0	Input Termination Center-Tap: Each input terminates to this pin. The VT pin provides a center-tap for each input (IN, /IN) to a termination network for maximum interface flexibility. See "Input Interface Application" section.
32, 28, 8, 4	SELA0, SELA1, SELB1, SELB0	Select Input: TTL/CMOS select input controls that selects inputs IN0, or IN1, for their respective banks A and B. Each input is internally connected to a $25k\Omega$ pull-up resistor and will default to a logic high state if left open.
9, 24	GND, Exposed Pad	Ground. Exposed pad must be connected to a ground plane that is the same potential as the device ground pins.
10, 13, 16, 17, 20, 23	VCC	Positive Power Supply: Bypass with $0.1\mu\text{F} \parallel 0.01\mu\text{F}$ low ESR capacitors as close to the V _{CC} pins as possible.
11, 12, 14, 15 18, 19, 21, 22	/QB0, QB0, QB1, /QB1, /QA1, QA1, /QA0, QA0	CML Differential Output Pairs: Differential buffered output copy of the selected input signal. The CML single-ended output swing is typically 400mV into 50Ω or 100Ω across the pair. Unused output pairs may be left floating with no impact on jitter. See "CML Output Termination" section.

TRUTH TABLE

SELA0	SELA1	QA0	QA1	SELB0	SELB1	QB0	QB1
0	0	INA0	INA0	0	0	INB0	INB0
0	1	INA0	INA1	0	1	INB1	INB1
1	0	INA1	INA0	1	0	INB1	INB0
1	1	INA1	INA1	1	1	INB1	INB1

FUNCTIONAL BLOCK DIAGRAM



Absolute Maximum Ratings⁽¹⁾

Supply Voltage (V_{CC})	−0.5V to +4.0V
Input Voltage (V_{IN})	−0.5V to V_{CC}
CML Output Voltage (V_{OUT})	V_{CC} −1.0V to V_{CC} +0.5V
Current (V_T)	
Source or Sink Current on VT pin	±100mA
Input Current (V_T)	
Source or Sink Current on IN, /IN	±50mA
Lead Temperature (soldering, 20 sec.)	260°C
Storage Temperature (T_S)	−65°C +150°C

Operating Ratings⁽²⁾

Supply Voltage (V_{CC})	+2.375V to +3.60V
Ambient Temperature (T_A)	−40°C to +85°C
Package Thermal Resistance ⁽³⁾	
MLF™ (θ_{JA})	
Still-Air	35°C/W
500lfpmin	28°C/W
MLF™ (ψ_{JB})	
Junction-to-board resistance	20°C/W

DC ELECTRICAL CHARACTERISTICS⁽⁴⁾ $T_A = -40^\circ\text{C}$ to $+85^\circ\text{C}$.

Symbol	Parameter	Condition	Min	Typ	Max	Units
V_{CC}	Power Supply Voltage	2.5V nominal 3.3V nominal	2.375 3.0	2.5 3.3	2.625 3.60	V V
I_{CC}	Power Supply Current	V_{CC} = max., current through internal 50Ω source termination resistor included.		200	250	mA
V_{IH}	Input HIGH Voltage	IN, /IN; Note 5	$V_{CC} - 1.6$		V_{CC}	V
V_{IL}	Input LOW Voltage	IN, /IN	0		$V_{IH} - 0.1$	V
V_{IN}	Input Voltage Swing	IN, /IN, see Figure 1a.	0.1		1.7	V
V_{DIFF_IN}	Differential Input Swing	IN, /IN, see Figure 1b.	0.2			V
R_{IN}	IN-to- V_T Resistance		40	50	60	Ω
IN to V_T					1.28	V

CML OUTPUT DC ELECTRICAL CHARACTERISTICS⁽⁴⁾ $V_{CC} = +3.3\text{V} \pm 10\%$ or $+2.5\text{V} \pm 5\%$; $R_L = 100\Omega$ across each pair; $T_A = -40^\circ\text{C}$ to $+85^\circ\text{C}$, unless otherwise stated.

Symbol	Parameter	Condition	Min	Typ	Max	Units
V_{OH}	Output HIGH Voltage	Q0, /Q0; Q1, /Q1	$V_{CC} - 0.020$		V_{CC}	V
V_{OUT}	Output Voltage Swing	Q0, /Q0; Q1, /Q1; see Figure 1a.	325	400	500	mV
V_{DIFF_OUT}	Differential Voltage Swing	Q0, /Q0; Q1, /Q1; see Figure 1b.	650	800	1000	mV
R_{OUT}	Output Source Impedance	Q0, /Q0; Q1, /Q1	40	50	60	Ω

Notes:

1. Permanent device damage may occur if "Absolute Maximum Ratings are exceeded." This is a stress rating only and functional operation is not implied at conditions other than those detailed in the operational sections of this data sheet. Exposure to "Absolute Maximum Rating" conditions for extended periods may affect device reliability.
2. The data sheet limits are not guaranteed if the device is operated beyond the operating ratings.
3. Thermal performance assumes exposed pad is soldered (or equivalent) to the device's most negative potential (GND) on the PCB. θ_{JA} and ψ_{JB} are characterized for 4-layer boards in still air, unless otherwise stated.
4. The circuit is designed to meet the DC specifications shown in the above table after thermal equilibrium has been established.
5. V_{IH} (min.) not lower than 1.2V.

AC ELECTRICAL CHARACTERISTICS⁽⁶⁾

$V_{CC} = +2.5V \pm 5\%$ or $+3.3V \pm 10\%$; $R_L = 100\Omega$ across each output pair; $T_A = -40^\circ\text{C}$ to $+85^\circ\text{C}$, unless otherwise stated.

Symbol	Parameter	Condition	Min	Typ	Max	Units
f_{MAX}	Maximum Operating Frequency	$V_{IN} \geq 100\text{mV}$; $V_{OUT} \geq 200\text{mV}$	Clock	6		GHz
			NRZ Data	10.7		Gbps
t_{pd}	Propagation Delay	IN-to-Q	200		350	ps
		SEL-to-Q	100		400	ps
t_{SKEW}	Channel-to-Channel Skew (Within Bank)	Note 7			20	ps
	Part-to-Part Skew	Note 8			75	ps
t_{JITTER}	Clock	Cycle-to-Cycle Jitter	Note 9		1	ps_{rms}
		Total Jitter	Note 10		10	ps_{pp}
	Data	Random Jitter	Note 11		1	ps_{rms}
		Deterministic Jitter	Note 12		10	ps_{pp}
	Crosstalk Induced Jitter		Note 13		0.7	ps_{rms}
t_r, t_f	Output Rise/Fall Time	20% to 80% at full swing.	25		60	ps

Notes:

6. High frequency AC-parameters are guaranteed by design and characterization.
7. Skew is measured between outputs of the same bank under identical transitions.
8. Skew is defined for two parts with identical power supply voltages at the same temperature and with no skew of the edges at the respective inputs.
9. Cycle-to-cycle jitter definition: The variation of periods between adjacent cycles, $T_n - T_{n-1}$ where T is the time between rising edges of the output signal.
10. Total jitter definition: With an ideal clock input of frequency $\leq f_{MAX}$, no more than one output edge in 10^{12} output edges will deviate by more than the specified peak-to-peak jitter value.
11. Random jitter is measured with a K28.7 comma detect character pattern, measured at 2.5Gbps–3.2Gbps.
11. Deterministic jitter is measured at 2.5Gbps–3.2Gbps with both K28.5 and 2²³–1 PRBS pattern.
13. Crosstalk induced jitter is defined as the added jitter that results from signals applied to two adjacent channels. It is measured at the output while applying similar, differential clock frequencies that are asynchronous with respect to each other at inputs.

SINGLE-ENDED AND DIFFERENTIAL SWINGS

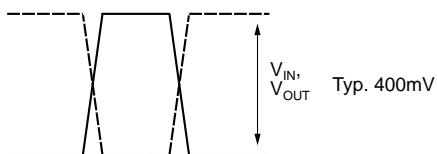


Figure 1a. Single-Ended Voltage Swing

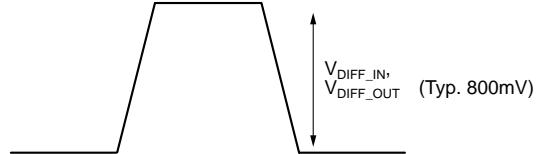
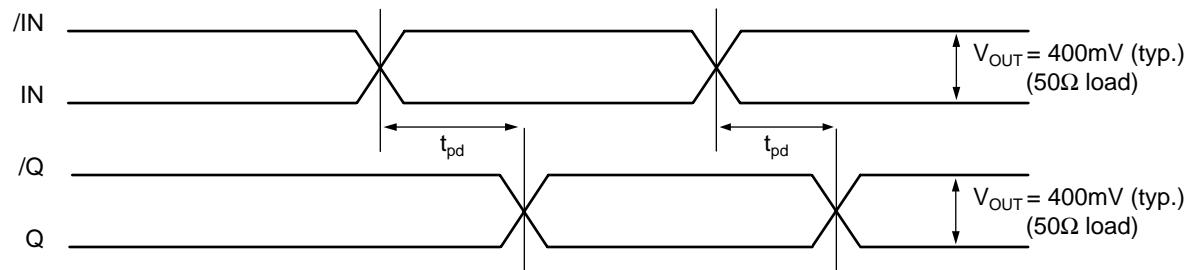
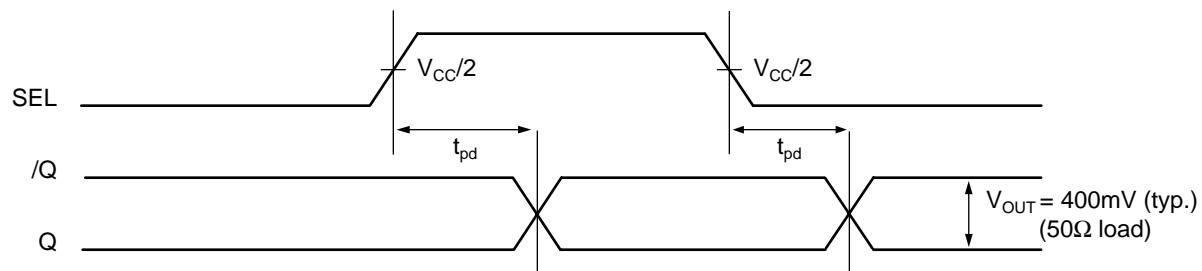


Figure 1b. Differential Voltage Swing

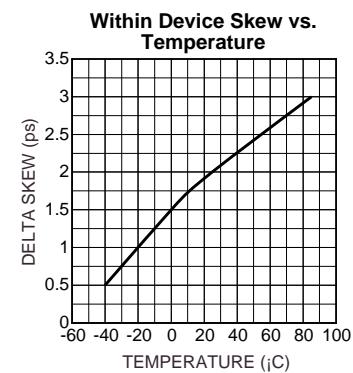
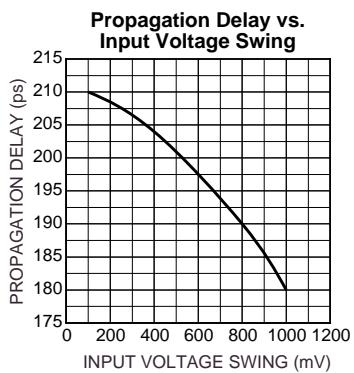
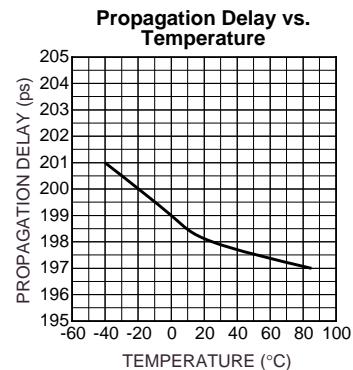
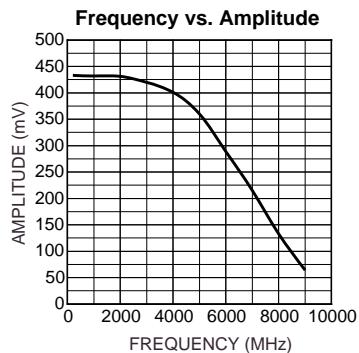
TIMING DIAGRAM**Figure 2a. AC Timing Diagram IN-to-Q**

IN0, /IN1 = LOW, /IN0, IN1 = HIGH

Figure 2b. AC Timing Diagram SEL-to-Q

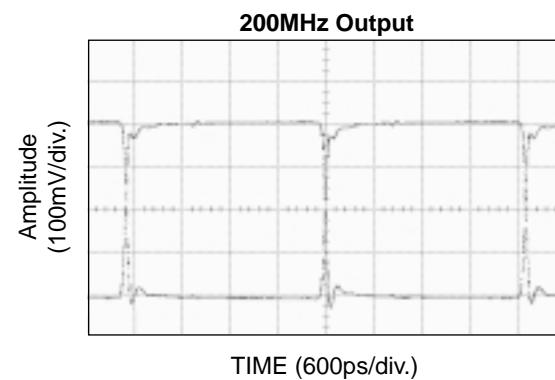
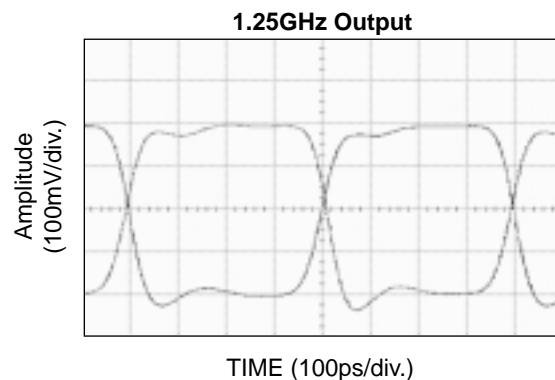
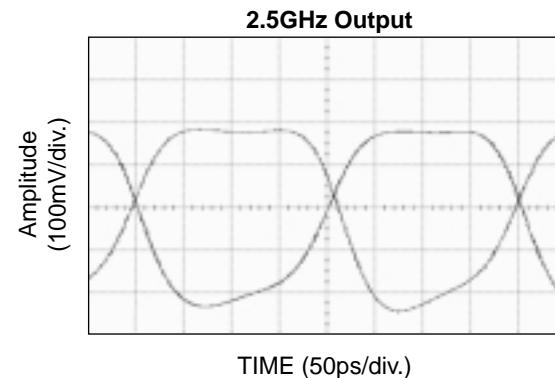
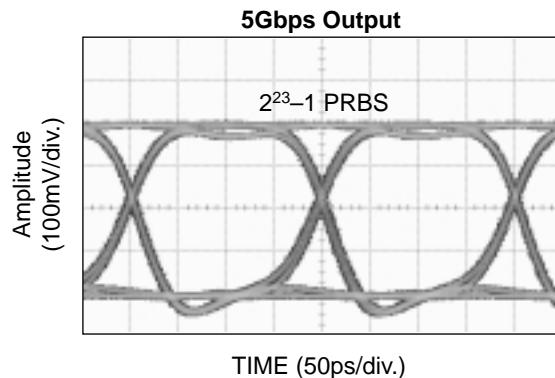
TYPICAL OPERATING CHARACTERISTICS

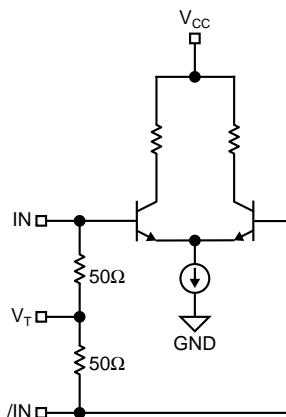
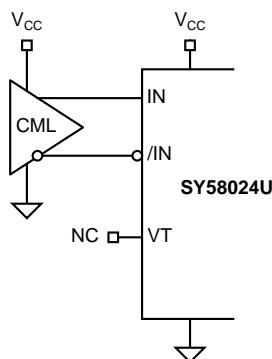
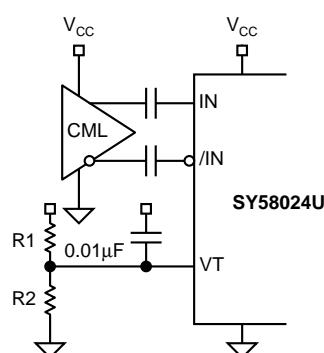
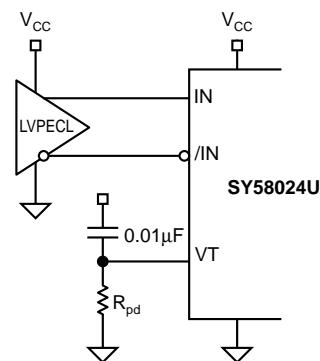
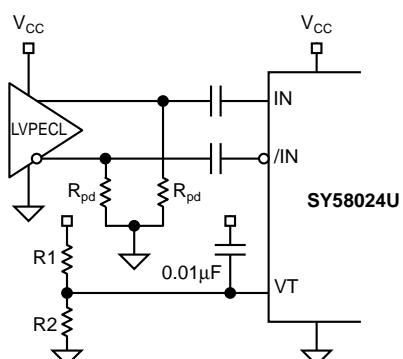
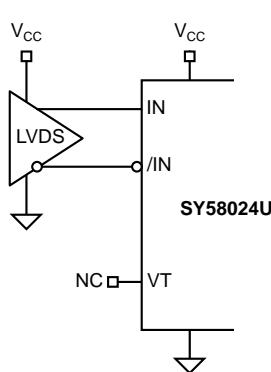
$V_{CC} = 2.5V$, $V_{IN} = 100mV$, $T_A = 25^\circ C$, unless otherwise noted.



FUNCTIONAL CHARACTERISTICS

$V_{CC} = 2.5V$, $V_{IN} = 100mV$, $T_A = 25^\circ C$, unless otherwise noted.



INPUT STAGE**Figure 3. Simplified Differential Input Buffer****INPUT INTERFACE APPLICATIONS****Figure 4a. DC-Coupled CML Input Interface***Option: may connect VT to Vcc***Figure 4b. AC-Coupled CML Input Interface**For 2.5V, R1 = 1kΩ, R2 = 1.1kΩ.
For 3.3V, R1 = 649Ω, R2 = 1kΩ.**Figure 4c. DC-Coupled LVPECL Input Interface**For 2.5V, Rpd = 19Ω.
For 3.3V, Rpd = 50Ω.For 2.5V, Rpd = 50Ω, R1 = 1kΩ, R2 = 1.1kΩ.
For 3.3V, Rpd = 100Ω, R1 = 649Ω, R2 = 1kΩ.**Figure 4d. AC-Coupled LVPECL Input Interface****Figure 4e. LVDS Input Interface**

CML OUTPUT TERMINATION

Figures 5 and Figure 6 illustrates how to terminate a CML output using both the AC-coupled and DC-coupled configuration. All outputs of the SY58024U are 50Ω with a 16mA current source.

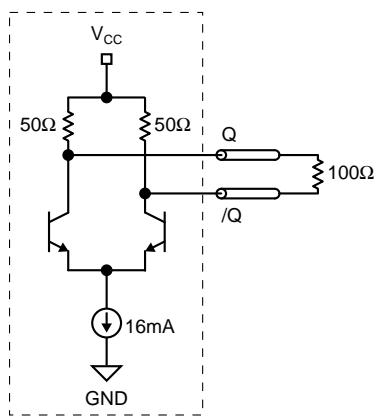


Figure 5. CML DC-Coupled Termination

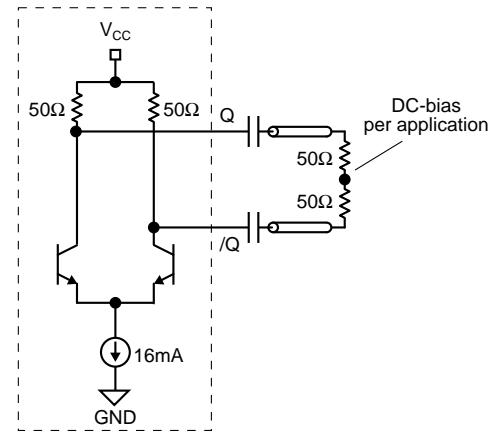
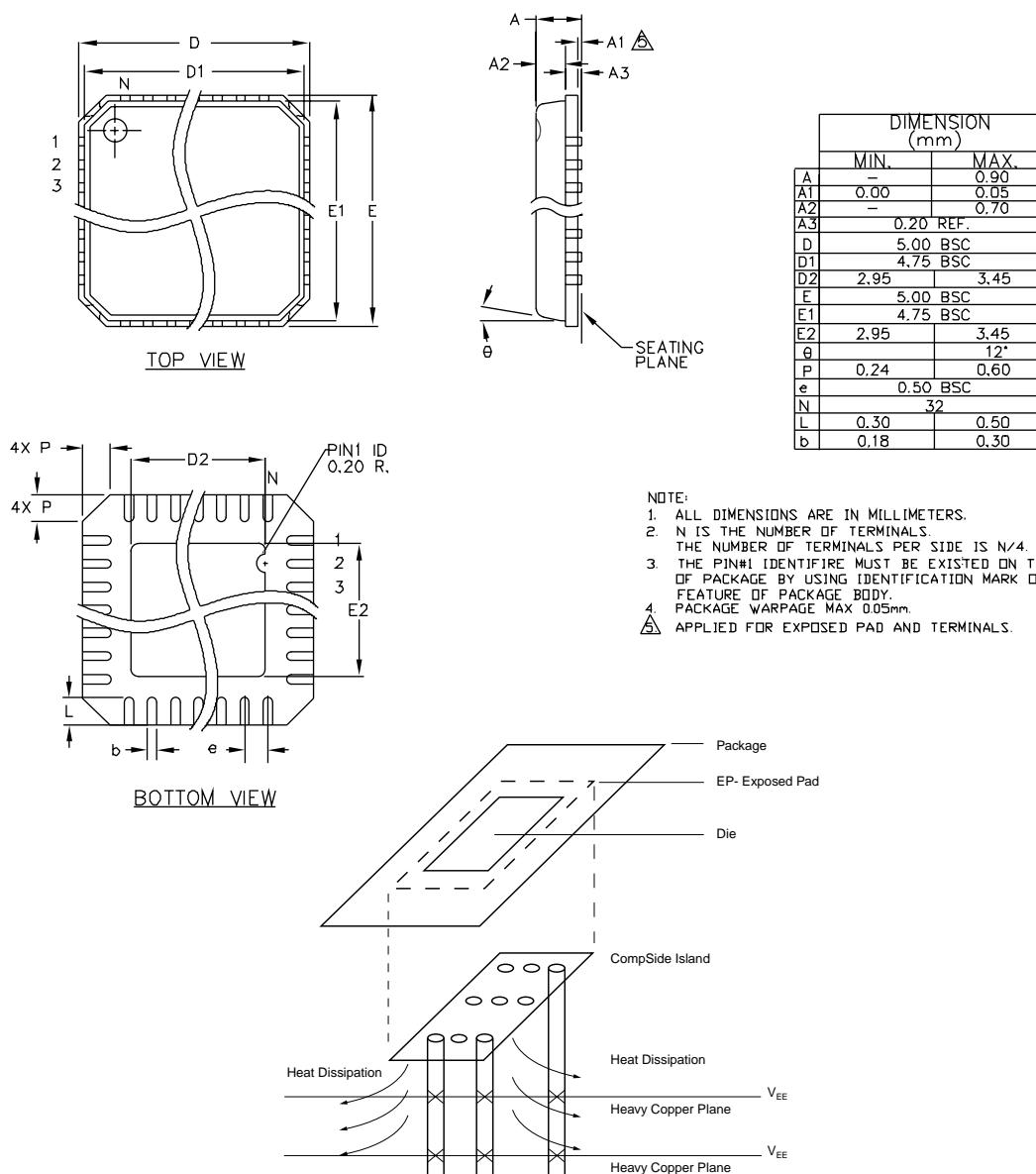


Figure 6. CML AC-Coupled Termination

RELATED PRODUCT AND SUPPORT DOCUMENTATION

Part Number	Function	Data Sheet Link
SY58023U	Ultra-low Jitter 2x2 Crosspoint Switch w/CML Outputs and Internal I/O Termination	http://www.micrel.com/product-info/products/SY58023U.shtml
SY58024U	Ultra-low Jitter Dual 2x2 Crosspoint Switch w/CML Outputs and Internal I/O Termination	http://www.micrel.com/product-info/products/sy58024u.shtml
	32-MLF Manufacturing Guidelines Exposed Pad Application Note	www.amkor.com/products/notes_papers/MLF_AppNote.pdf
	HBW Solutions	http://www.micrel.com/product-info/as/solutions.shtml

32 LEAD MicroLeadFrame™ (MLF-32)



PCB Thermal Consideration for 32-Pin MLF™ Package
(Always solder, or equivalent, the exposed pad to the PCB)

Package Notes:

1. Package meets Level 2 qualification.
2. All parts are dry-packaged before shipment.
3. Exposed pads must be soldered to a ground for proper thermal management.

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